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## LM3702/LM3703 Microprocessor Supervisory Circuits with Low Line Output and Manual Reset

Check for Samples: [LM3702](#), [LM3703](#)

### FEATURES

- Standard Reset Threshold Voltage: 3.08V
- Custom Reset Threshold Voltages: For Other Voltages Between 2.2V and 5.0V in 10mV Increments, Contact Texas Instruments.
- No External Components Required
- Manual-Reset Input
- $\overline{\text{RESET}}$  (LM3702) or RESET (LM3703) Outputs
- Precision Supply Voltage Monitor
- Factory Programmable Reset Timeout Delay
- Available in DSBGA Package for Minimum Footprint
- $\pm 0.5\%$  Reset Threshold Accuracy at Room Temperature
- $\pm 2\%$  Reset Threshold Accuracy Over Temperature Extremes
- Reset Assertion Down to 1V  $V_{CC}$  ( $\overline{\text{RESET}}$  Option Only)
- 28  $\mu\text{A}$   $V_{CC}$  Supply Current

### DESCRIPTION

The LM3702/LM3703 series of microprocessor supervisory circuits provide the maximum flexibility for monitoring power supplies and battery controlled functions in systems without backup batteries. The LM3702/LM3703 series are available in a 9-bump DSBGA package.

Built-in features include the following:

**Reset:** Reset is asserted during power-up, power-down, and brownout conditions. RESET is ensured down to  $V_{CC}$  of 1.0V.

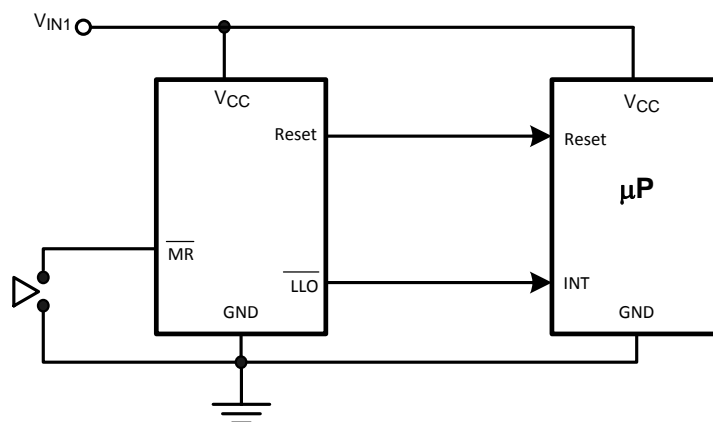
**Manual Reset Input:** An input that asserts reset when pulled low.

**Low Line Output:** This early power failure warning indicator goes low when the supply voltage drops to a value which is 2% higher than the reset threshold voltage.

### APPLICATIONS

- Embedded Controllers and Processors
- Intelligent Instruments
- Automotive Systems
- Critical  $\mu\text{P}$  Power Monitoring

### Typical Application



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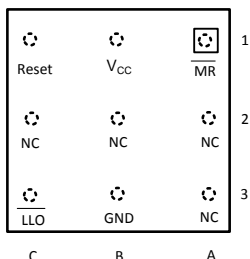
**LM3702, LM3703**

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**Connection Diagram**

**Figure 1.**

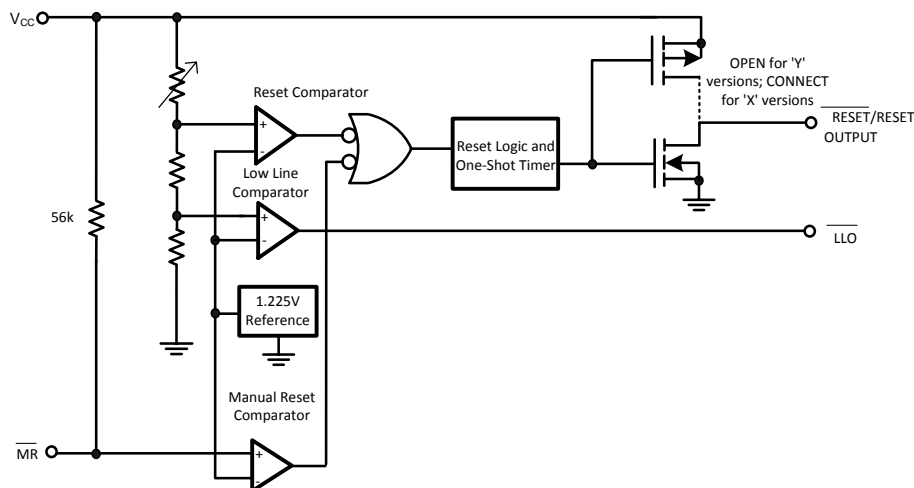


**Figure 2. Top View  
(looking from the coating side)  
DSBGA 9 Bump Package**

**PIN DESCRIPTIONS**

Bump No.	Name	Function
A1	$\overline{MR}$	Manual-Reset input. When $\overline{MR}$ is less than $V_{MRT}$ (Manual Reset Threshold) $\overline{RESET}$ /RESET is engaged.
B1	$V_{CC}$	Power Supply input.
C1	$\overline{RESET}$	Reset Logic Output. Pulses low for $t_{RP}$ (Reset Timeout Period) when triggered, and stays low whenever $V_{CC}$ is below the reset threshold or when $\overline{MR}$ is below $V_{MRT}$ . It remains low for $t_{RP}$ after either $V_{CC}$ rises above the reset threshold, or after $\overline{MR}$ input rises above $V_{MRT}$ (LM3702 only).
	RESET	Reset Logic Output. RESET is the inverse of $\overline{RESET}$ (LM3703 only).
C3	$\overline{LLO}$	Low-Line Logic Output. Early Power-Fail warning output. Low when $V_{CC}$ falls below $V_{LLOT}$ (Low-Line Output Threshold). This output can be used to generate an NMI (Non-Maskable Interrupt) to provide an early warning of imminent power-failure.
B3	GND	Ground reference for all signals.
A2, A3, C2	NC	No Connect.
B2	NC	No Connect. Test input used at factory only. Leave floating.

**Block Diagram**



**Table 1. Table Of Functions**

Part Number	Active Low Reset	Active High Reset	Output (X = totem-pole) (Y = open-drain)	Reset Timeout Period	Manual Reset	Low Line Output
LM3702	x		X, Y <sup>(1)</sup>	Customized	x	x
LM3703		x	X	Customized	x	x

(1) = available upon request. Contact TI



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

**ABSOLUTE MAXIMUM RATINGS<sup>(1)(2)</sup>**

Supply Voltage (V <sub>CC</sub> )	-0.3V to 6.0V	
All Other Inputs	-0.3V to V <sub>CC</sub> + 0.3V	
ESD Ratings <sup>(3)</sup>	Human Body Model	1.5kV
	Machine Model	150V
Power Dissipation	See <sup>(4)</sup>	

- (1) **Absolute Maximum Ratings** indicate limits beyond which damage to the device may occur. **Operating Ratings** indicate conditions for which the device is intended to be functional, but do not ensure specific performance limits. For ensured specifications and test conditions, see the Electrical Characteristics. The ensured specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed conditions.
- (2) If Military/Aerospace specified devices are required, please contact the TI Sales Office/ Distributors for availability and specifications.
- (3) The Human Body model is a 100 pF capacitor discharged through a 1.5 kΩ resistor into each pin. The machine model is a 200pF capacitor discharged directly into each pin.
- (4) The maximum allowable power dissipation is a function of the maximum junction temperature, T<sub>J</sub>(MAX), the junction-to-ambient thermal resistance, θ<sub>J-A</sub>, and the ambient temperature, T<sub>A</sub>. The maximum allowable power dissipation at any ambient temperature is calculated using:

$$P(\text{MAX}) = \frac{T_J(\text{MAX}) - T_A}{\theta_{J-A}}$$

Where the value of θ<sub>J-A</sub> for the DSBGA package is 220°C/W.

**OPERATING RATINGS<sup>(1)</sup>**

Temperature Range	-40°C ≤ T <sub>J</sub> ≤ 85°C
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- (1) **Absolute Maximum Ratings** indicate limits beyond which damage to the device may occur. **Operating Ratings** indicate conditions for which the device is intended to be functional, but do not ensure specific performance limits. For ensured specifications and test conditions, see the Electrical Characteristics. The ensured specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed conditions.

**LM3702/LM3703 SERIES ELECTRICAL CHARACTERISTICS**

Limits in the standard typeface are for T<sub>J</sub> = 25°C and limits in **boldface type** apply over full operating range. Unless otherwise specified: V<sub>CC</sub> = +2.2V to 5.5V.

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>POWER SUPPLY</b>						
V <sub>CC</sub>	Operating Voltage Range: V <sub>CC</sub>	LM3702	<b>1.0</b>		<b>5.5</b>	V
		LM3703	<b>1.2</b>		<b>5.5</b>	
I <sub>CC</sub>	V <sub>CC</sub> Supply Current	All inputs = V <sub>CC</sub> ; all outputs floating		28	<b>50</b>	μA
<b>RESET THRESHOLD</b>						
V <sub>RST</sub>	Reset Threshold	V <sub>CC</sub> falling	-0.5 <b>-2</b>	V <sub>RST</sub>	+0.5 <b>+2</b>	%
		V <sub>CC</sub> falling: T <sub>A</sub> = 0°C to 70°C	<b>-1.5</b>		<b>+1.5</b>	
V <sub>RSTH</sub>	Reset Threshold Hysteresis			0.0032•V <sub>RST</sub>		mV
t <sub>RP</sub>	Reset Timeout Period	Reset Timeout Period = A	<b>1</b>	1.4	<b>2</b>	ms
		Reset Timeout Period = B	<b>20</b>	28	<b>40</b>	
		Reset Timeout Period = C	<b>140</b>	200	<b>280</b>	
		Reset Timeout Period = D	<b>1120</b>	1600	<b>2240</b>	
t <sub>RD</sub>	V <sub>CC</sub> to Reset Delay	V <sub>CC</sub> falling at 1mV/μs		20		μs

## LM3702, LM3703

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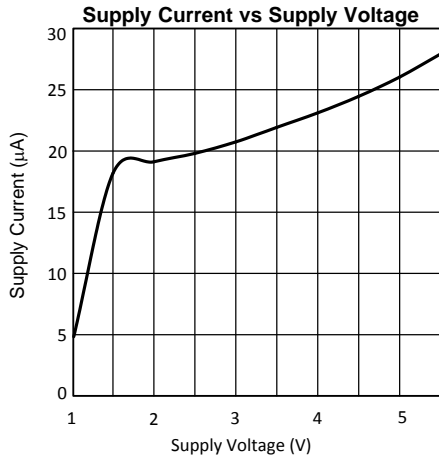
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### LM3702/LM3703 SERIES ELECTRICAL CHARACTERISTICS (continued)

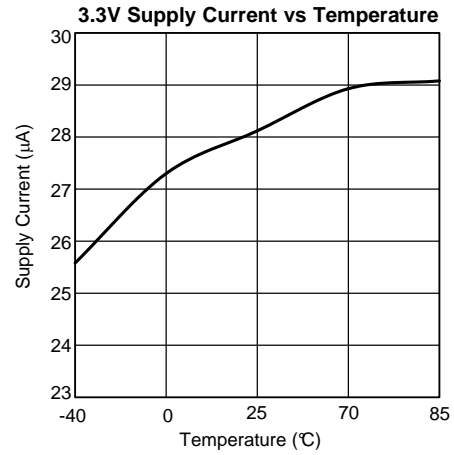
Limits in the standard typeface are for  $T_J = 25^\circ\text{C}$  and limits in **boldface type** apply over full operating range. Unless otherwise specified:  $V_{CC} = +2.2\text{V}$  to  $5.5\text{V}$ .

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>RESET (LM3703)</b>						
$V_{OL}$	RESET	$V_{CC} > 2.25\text{V}$ , $I_{SINK} = 900\mu\text{A}$			<b>0.3</b>	V
		$V_{CC} > 2.7\text{V}$ , $I_{SINK} = 1.2\text{mA}$			<b>0.3</b>	
		$V_{CC} > 4.5\text{V}$ , $I_{SINK} = 3.2\text{mA}$			<b>0.4</b>	
$V_{OH}$	RESET	$V_{CC} > 1.2\text{V}$ , $I_{SOURCE} = 50\mu\text{A}$	<b><math>0.8 V_{CC}</math></b>			V
		$V_{CC} > 1.8\text{V}$ , $I_{SOURCE} = 150\mu\text{A}$	<b><math>0.8 V_{CC}</math></b>			
		$V_{CC} > 2.25\text{V}$ , $I_{SOURCE} = 300\mu\text{A}$	<b><math>0.8 V_{CC}</math></b>			
		$V_{CC} > 2.7\text{V}$ , $I_{SOURCE} = 500\mu\text{A}$	<b><math>0.8 V_{CC}</math></b>			
		$V_{CC} > 4.5\text{V}$ , $I_{SOURCE} = 800\mu\text{A}$	<b><math>V_{CC} - 1.5\text{V}</math></b>			
$I_{LKG}$	Output Leakage Current	$V_{RESET} = 5.5\text{V}$			<b>1.0</b>	$\mu\text{A}$
<b>RESET (LM3702)</b>						
$V_{OL}$	$\overline{\text{RESET}}$	$V_{CC} > 1.0\text{V}$ , $I_{SINK} = 50\mu\text{A}$			<b>0.3</b>	V
		$V_{CC} > 1.2\text{V}$ , $I_{SINK} = 100\mu\text{A}$			<b>0.3</b>	
		$V_{CC} > 2.25\text{V}$ , $I_{SINK} = 900\mu\text{A}$			<b>0.3</b>	
		$V_{CC} > 2.7\text{V}$ , $I_{SINK} = 1.2\text{mA}$			<b>0.3</b>	
		$V_{CC} > 4.5\text{V}$ , $I_{SINK} = 3.2\text{mA}$			<b>0.4</b>	
$V_{OH}$	$\overline{\text{RESET}}$	$V_{CC} > 2.25\text{V}$ , $I_{SOURCE} = 300\mu\text{A}$	<b><math>0.8 V_{CC}</math></b>			V
		$V_{CC} > 2.7\text{V}$ , $I_{SOURCE} = 500\mu\text{A}$	<b><math>0.8 V_{CC}</math></b>			
		$V_{CC} > 4.5\text{V}$ , $I_{SOURCE} = 800\mu\text{A}$	<b><math>V_{CC} - 1.5\text{V}</math></b>			
<b>MR</b>						
$V_{MRT}$	$\overline{\text{MR}}$ Input Threshold	$\overline{\text{MR}}$ , Low			<b>0.8</b>	V
		$\overline{\text{MR}}$ , High	<b>2.0</b>			
$V_{MRTH}$	$\overline{\text{MR}}$ Threshold Hysteresis	$\overline{\text{MR}}$ falling: $V_{CC} = V_{RST\ MAX}$ to $5.5\text{V}$		$0.0032 \cdot V_{RST}$		mV
$R_{MR}$	$\overline{\text{MR}}$ Pull-up Resistance		<b>35</b>	56	<b>75</b>	k $\Omega$
$t_{MD}$	$\overline{\text{MR}}$ to Reset Delay			12		$\mu\text{s}$
$t_{MR}$	$\overline{\text{MR}}$ Pulse Width		<b>25</b>			$\mu\text{s}$
<b>LLO</b>						
$V_{OL}$	LLO Output Voltage	$V_{CC} > 2.25\text{V}$ , $I_{SINK} = 900\mu\text{A}$			<b>0.3</b>	V
		$V_{CC} > 2.7\text{V}$ , $I_{SINK} = 1.2\text{mA}$			<b>0.3</b>	
		$V_{CC} > 4.5\text{V}$ , $I_{SINK} = 3.2\text{mA}$			<b>0.4</b>	
$V_{OH}$	LLO Output Voltage	$V_{CC} > 2.25\text{V}$ , $I_{SOURCE} = 300\mu\text{A}$	<b><math>0.8 V_{CC}</math></b>			V
		$V_{CC} > 2.7\text{V}$ , $I_{SOURCE} = 500\mu\text{A}$	<b><math>0.8 V_{CC}</math></b>			
		$V_{CC} > 4.5\text{V}$ , $I_{SOURCE} = 800\mu\text{A}$	<b><math>V_{CC} - 1.5\text{V}</math></b>			
<b>LLO OUTPUT</b>						
$V_{LLOT}$	LLO Output Threshold ( $V_{LLO} - V_{RST}$ , $V_{CC}$ falling)		<b><math>1.01 \cdot V_{RST}</math></b>	$1.02 \cdot V_{RST}$	<b><math>1.03 \cdot V_{RST}</math></b>	V
$V_{LLOTH}$	Low-Line Comparator Hysteresis			$0.0032 \cdot V_{RST}$		mV
$t_{CD}$	Low-Line Comparator Delay	$V_{CC}$ falling at $1\text{mV}/\mu\text{s}$		20		$\mu\text{s}$

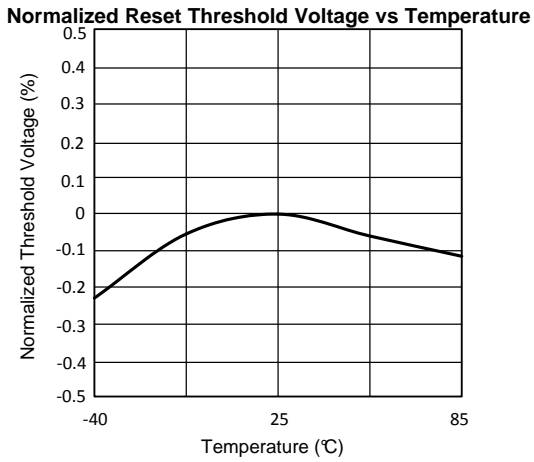
**TYPICAL PERFORMANCE CHARACTERISTICS**



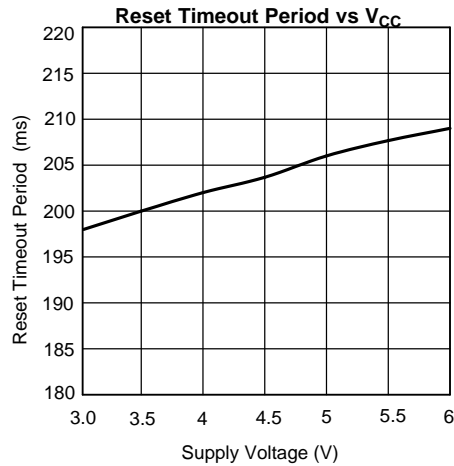
**Figure 3.**



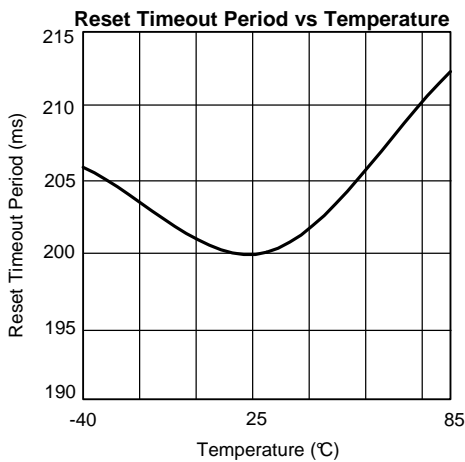
**Figure 4.**



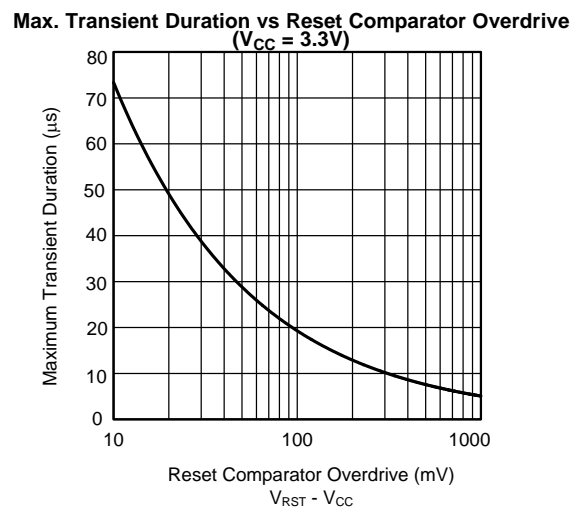
**Figure 5.**



**Figure 6.**



**Figure 7.**



**Figure 8.**

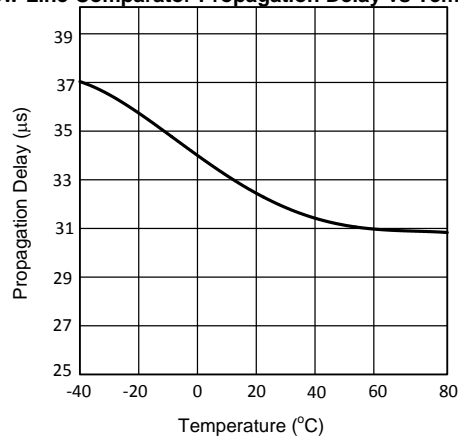
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**TYPICAL PERFORMANCE CHARACTERISTICS (continued)**

**Low-Line Comparator Propagation Delay vs Temperature**



**Figure 9.**

## CIRCUIT INFORMATION

### RESET OUTPUT

The Reset input of a  $\mu\text{P}$  initializes the device into a known state. The LM3702/LM3703 microprocessor supervisory circuits assert a forced reset output to prevent code execution errors during power-up, power-down, and brownout conditions.

$\overline{\text{RESET}}$  is ensured valid for  $V_{\text{CC}} > 1\text{V}$ . Once  $V_{\text{CC}}$  exceeds the reset threshold, an internal timer maintains the output for the reset timeout period. After this interval, reset goes high. The LM3702 offers an active-low  $\overline{\text{RESET}}$ ; The LM3703 offers an active-high  $\overline{\text{RESET}}$ .

Any time  $V_{\text{CC}}$  drops below the reset threshold (such as during a brownout), the reset activates. When  $V_{\text{CC}}$  again rises above the reset threshold, the internal timer starts. Reset holds until  $V_{\text{CC}}$  exceeds the reset threshold for longer than the reset timeout period. After this time, reset releases.

The Manual Reset input ( $\overline{\text{MR}}$ ) will initiate a forced reset also. See the [MANUAL RESET INPUT \( \$\overline{\text{MR}}\$ \)](#) section.

### RESET THRESHOLD

The LM3702/LM3703 family is available with a reset voltage of 3.08V. Other reset thresholds in the 2.20V to 5.0V range, in steps of 10 mV, are available; contact TI for details.

### MANUAL RESET INPUT ( $\overline{\text{MR}}$ )

Many  $\mu\text{P}$ -based products require a manual reset capability, allowing the operator to initiate a reset. The  $\overline{\text{MR}}$  input is fully debounced and provides an internal 56 k $\Omega$  pull-up. When the  $\overline{\text{MR}}$  input is pulled below  $V_{\text{MRT}}$  (1.225V) for more than 25  $\mu\text{s}$ , reset is asserted after a typical delay of 12  $\mu\text{s}$ . Reset remains active as long as  $\overline{\text{MR}}$  is held low, and releases after the reset timeout period expires after  $\overline{\text{MR}}$  rises above  $V_{\text{MRT}}$ . Use  $\overline{\text{MR}}$  with digital logic to assert or to daisy chain supervisory circuits. It may be used as another low-line comparator by adding a buffer.

### LOW-LINE OUTPUT ( $\overline{\text{LLO}}$ )

The low-line output comparator is typically used to provide a non-maskable interrupt to a  $\mu\text{P}$  when  $V_{\text{CC}}$  begins falling.  $\overline{\text{LLO}}$  monitors  $V_{\text{CC}}$  and goes low when  $V_{\text{CC}}$  falls below  $V_{\text{LLOT}}$  (typically  $1.02 \cdot V_{\text{RST}}$ ) with hysteresis of  $0.0032 \cdot V_{\text{RST}}$ .

### SPECIAL PRECAUTIONS FOR THE DSBGA PACKAGE

As with most integrated circuits, the LM3702 and LM3703 are sensitive to exposure from visible and infrared (IR) light radiation. Unlike a plastic encapsulated IC, the DSBGA package has very limited shielding from light, and some sensitivity to light reflected from the surface of the PC board or long wavelength IR entering the die from the side may be experienced. This light could have an unpredictable affect on the electrical performance of the IC. Care should be taken to shield the device from direct exposure to bright visible or IR light during operation.

### DSBGA MOUNTING

The DSBGA package requires specific mounting techniques which are detailed in TI Application Note AN-1112 ([SNVA009](#)). Referring to the section **Surface Mount Technology (SMT) Assembly Considerations**, it should be noted that the pad style which must be used with the 9-pin package is the NSMD (non-solder mask defined) type.

For best results during assembly, alignment ordinals on the PC board may be used to facilitate placement of the DSBGA device.

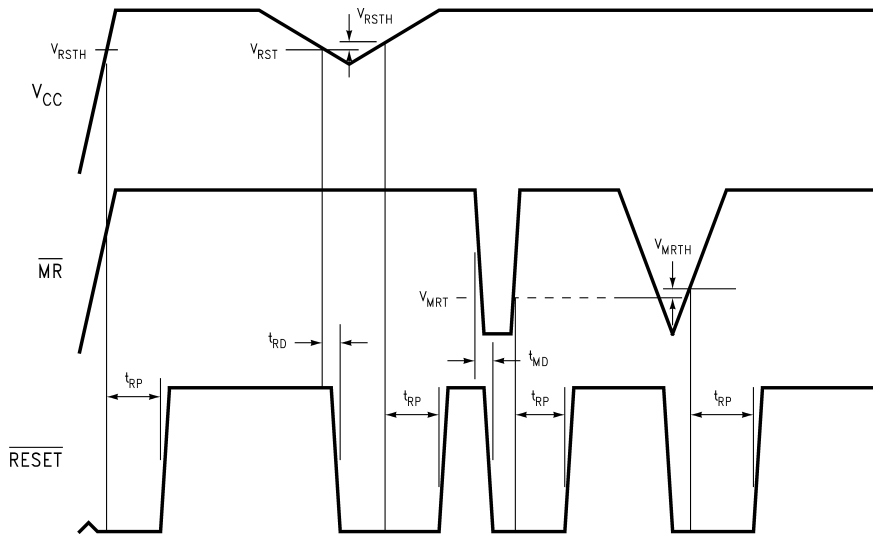


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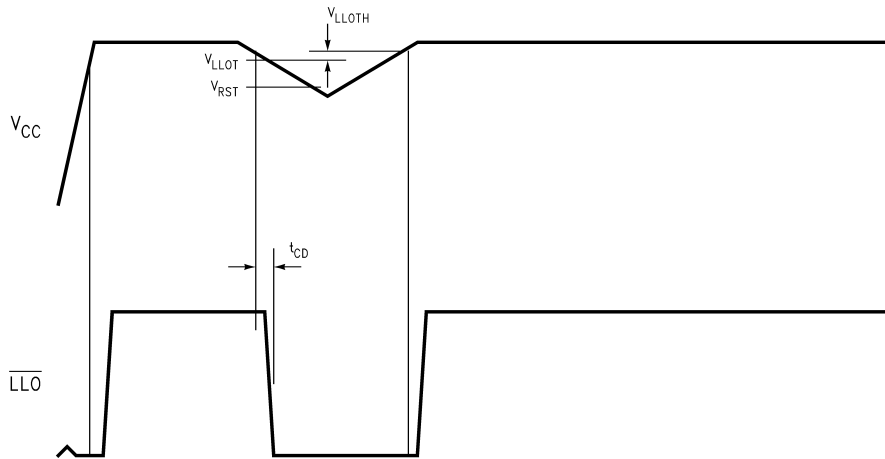
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**Timing Diagrams**

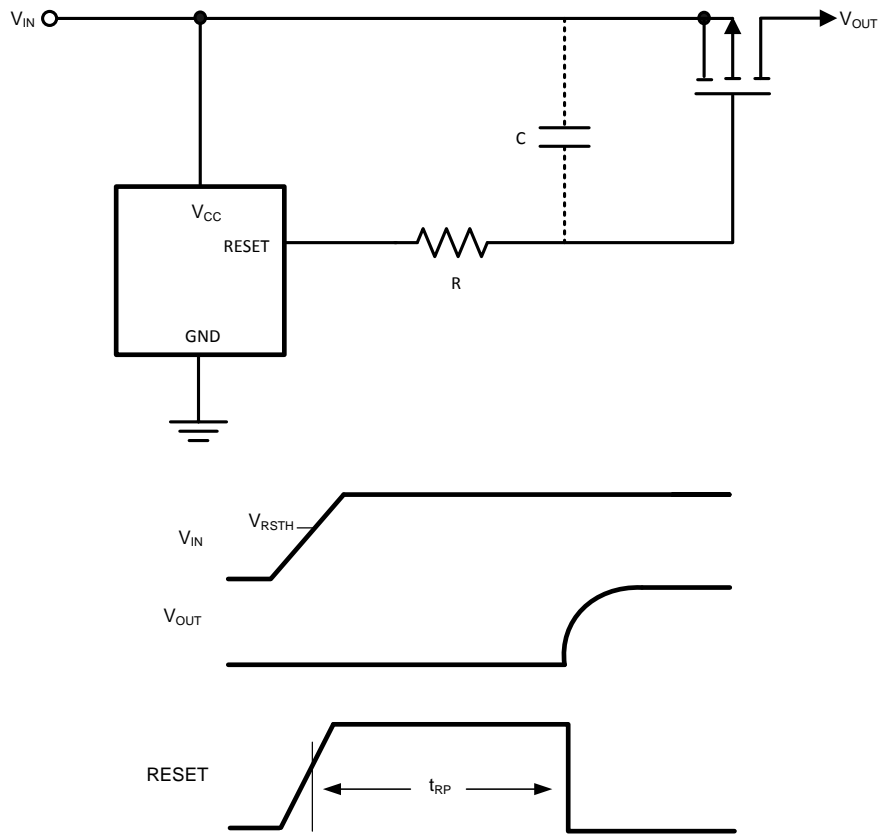


**Figure 10. LM3702 Reset Time with  $\overline{MR}$**



**Figure 11.  $\overline{LLO}$  Output**

**Typical Application Circuits**

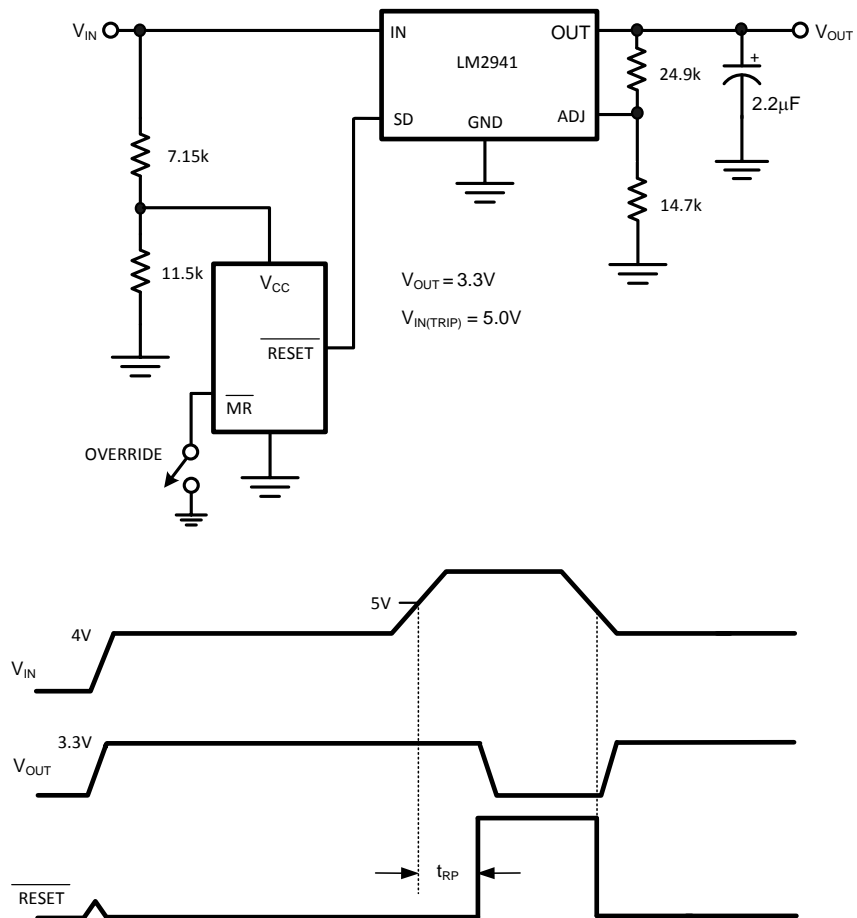


**Figure 12. LM3703 Power-On Delay**

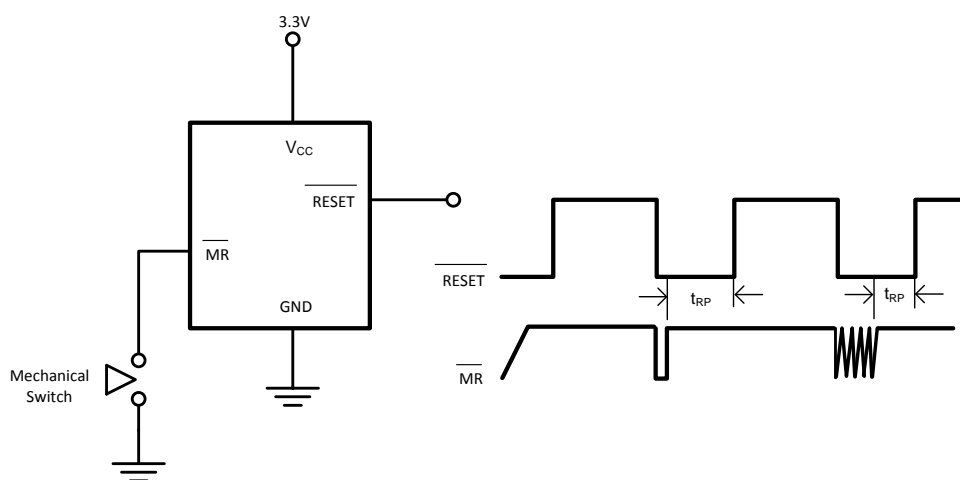
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**Figure 13. Regulator/Switch with Long-Term Overvoltage Lockout Prevents Overdissipation in Linear Regulator**



**Figure 14. Switch Debouncer**

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